



## STK400-040

### AF Power Amplifier (Split Power Supply) (25 W + 25 W + 25 W min, THD = 0.4%)

#### Overview

Now, thick-film audio power amplifier ICs are available with pin-compatibility to permit a single PCB to be designed and amplifier output capacity changed simply by installing a hybrid IC. This new series was developed with this kind of pin-compatibility to ensure integration between systems everywhere. With this new series of IC, even changes from 3-channel amplifier to 2-channel amplifiers is possible using the same PCB. In addition, this new series of ICs has a  $6/3\Omega$  drive in order to support the low impedance of modern speakers.

#### Features

- Pin-compatible

STK400-000 series (3-channel, single package)



STK401-000 series (2-channel, single package)

- Output load impedance  $R_L = 6\Omega/3\Omega$  supported
- New pin arrangement

To simplify input/output pattern layout and minimize the effects of pattern layout on operational characteristics, pin assignments are grouped into blocks consisting of input, output and power systems.

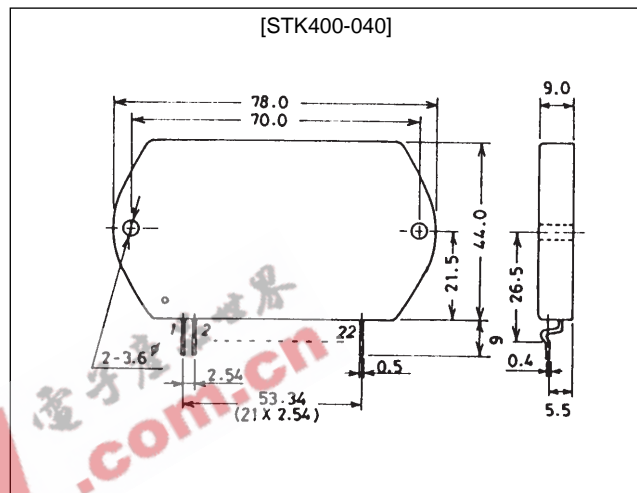
- Few external circuits

Compared to those series used until now, capacitors and boot-strap resistors for external circuits can be greatly reduced.

#### Package Dimensions

unit: mm

4086A



## Specifications

### Absolute Maximum Ratings at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	V <sub>CC</sub> max		±36	V
Thermal resistance	θ <sub>j-c</sub>	Per power transistor	2.1	°C/W
Junction temperature	T <sub>j</sub>		150	°C
Operating substrate temperature	T <sub>c</sub>		125	°C
Storage temperature range	T <sub>stg</sub>		-30 to +125	°C
Available time for short-circuit	t <sub>s</sub>	V <sub>CC</sub> = ±25 V, R <sub>L</sub> = 6 Ω, f = 50 Hz, P <sub>O</sub> = 25 W	1	s

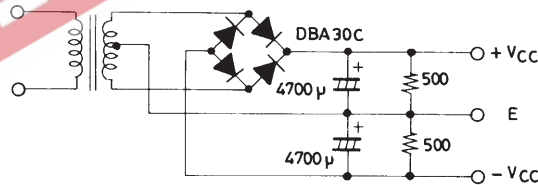
### Operating Characteristics at Ta = 25°C, R<sub>L</sub> = 6Ω, R<sub>g</sub> = 600Ω, VG = 40dB, R<sub>L</sub> (non-inductive)

Parameter	Symbol	Conditions	min	typ	max	Unit
Quiescent current	I <sub>CCO</sub>	V <sub>CC</sub> = ±30 V	30	90	150	mA
Output power	P <sub>O</sub> (1)	V <sub>CC</sub> = ±25 V, f = 20 Hz to 20 kHz, THD = 0.4%	25	30		W
	P <sub>O</sub> (2)	V <sub>CC</sub> = ±21 V, f = 1 kHz, THD = 1.0%, R <sub>L</sub> = 3 Ω	25	30		W
Total harmonic distortion	THD (1)	V <sub>CC</sub> = ±25 V, f = 20 Hz to 20 kHz, P <sub>O</sub> = 1.0 W			0.4	%
	THD (2)	V <sub>CC</sub> = ±25 V, f = 1 kHz, P <sub>O</sub> = 5.0 W		0.02		%
Frequency response	f <sub>L</sub> , f <sub>H</sub>	V <sub>CC</sub> = ±25 V, P <sub>O</sub> = 1.0 W, +0 -3 dB		20 to 50 k		Hz
Input impedance	r <sub>i</sub>	V <sub>CC</sub> = ±25 V, f = 1 kHz, P <sub>O</sub> = 1.0 W		55		kΩ
Output noise voltage	V <sub>NO</sub>	V <sub>CC</sub> = ±30 V, R <sub>g</sub> = 10 kΩ			1.2	mVrms
Neutral voltage	V <sub>N</sub>	V <sub>CC</sub> = ±30 V	-70	0	+70	mV

### Notes

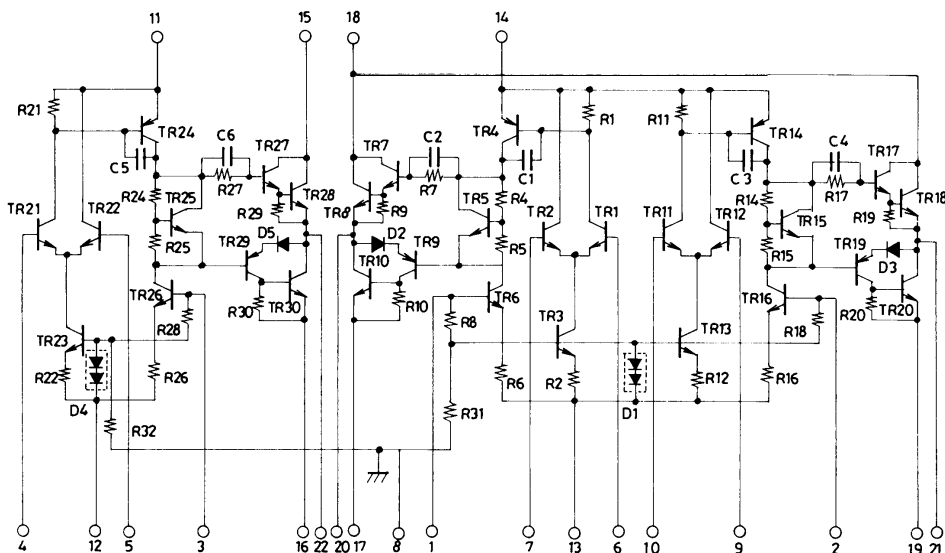
- Use rated power supply for test unless otherwise specified.
- When measuring available time for short-circuit and output noise voltage use transformer power supply indicated below.
- Output noise voltage is represented by the peak value rms (VTVM) for mean reading. Use an AC stabilized power supply (50 Hz) on the primary side to eliminate the effect of AC flicker noise.

Specified Transformer Power Supply  
(RP-25 Equivalent)



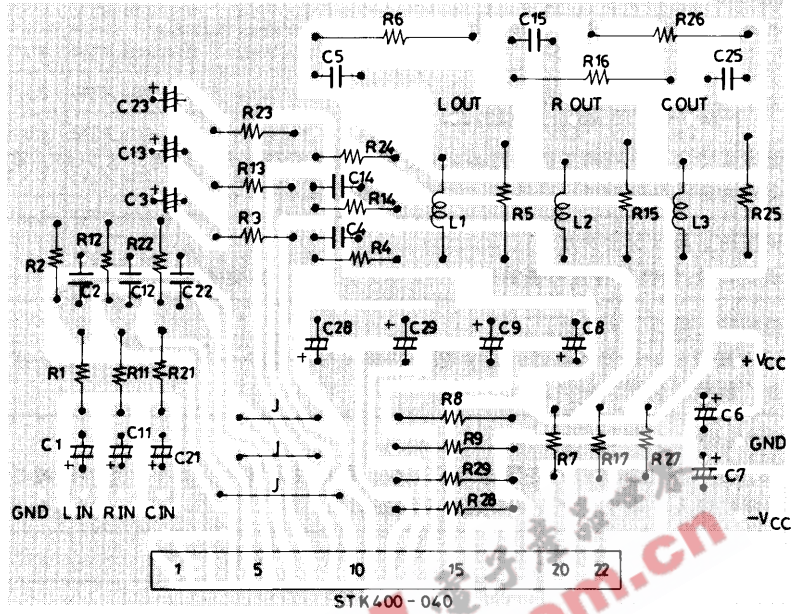
Unit (resistance:Ω, capacitance:F)

### Internal Equivalent Circuit



Pattern Example for PCB used with either 2- or 3-channel Amplifiers.  
Sample Application Circuit

STK 400-000 Series

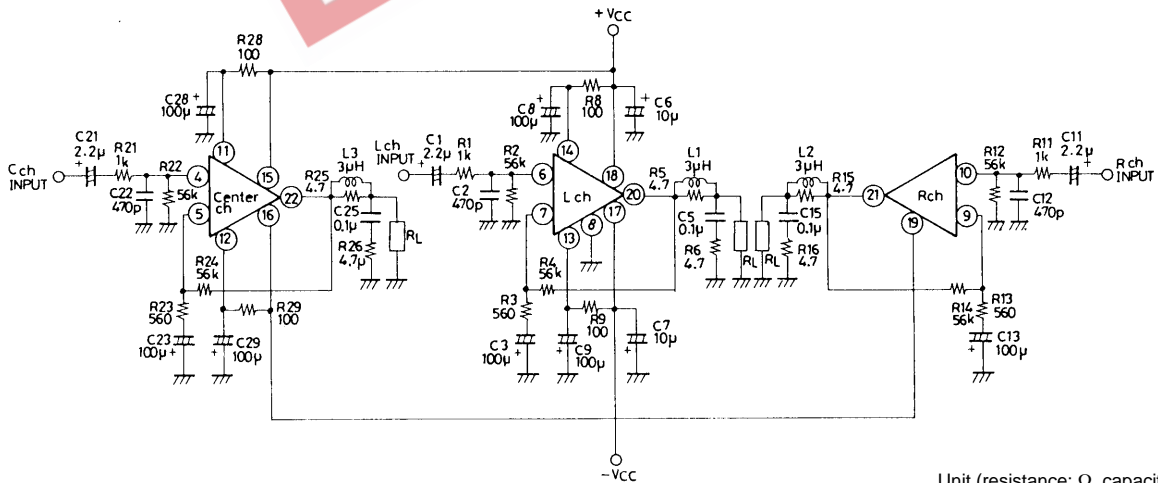


Copper (Cu) foil surface

Unit (resistance:Ω, capacitance:F)

In the STK 401-000 series, pin No.6 corresponds to pin No.1.

Sample Application Circuit



**Description of External Circuits**

C1, 11, 21	For input coupling capacitor. Used for current blocking. When capacitor reactance with low frequency is increased, the reactance value should be reduced in order to reduce the output noise from the signal resistance dependent 1/f noise. In response to the popping noise which occurs when the system power is turned on, C1 and C11 which determine the decay time constant on the input side are increased while C3, C13 and C23 on the NF side are decreased.
C2, 12, 22	For input filter capacitor. Permits high-region noise reduction by utilizing filter constructed with R1, R11 and R21.
C3, 13, 23	For NF capacitor. This capacitor determines the decline of the cut-off frequency and is calculated according to the following equation. $f_L = \frac{1}{2\pi \times C3 (13, 23,) \times R3 (13, 23)}$ <p>For the purpose of achieving voltage gains prior to reduction, it is best that C3, C13 and C23 are large. However, because the shock noise which occurs when the system power is turned on tends to increase, values larger than those absolutely necessary should be avoided.</p>
C5, 15, 25	For oscillation prevention capacitor. A Mylar capacitor with temperature and frequency features is recommended.
C6, 7	For oscillation prevention capacitor. To ensure safe IC functioning, the capacitor should be installed as close as possible to the IC power pin to reduce power impedance. An electrolytic capacitor is good.
C8, 9, 28, 29	For decoupling capacitor. Reduces shock noise during power up using decay time constant circuits with R8, R9, R28 and R29 and eliminates components such as ripples crossing over into the input side from the power line.
R1, 11, 21	For input filter applied resistor.
R2, 12, 22	For input bias resistor. The input pin is biased to zero potential. Input impedance is mostly decided with this resistance value.
R3, 13, 23 R4, 14, 24	For resistors to determine voltage gain (VG). We recommend a VG = 40 dB using R3, R13, R23 = 560Ω and R4, R14 and R24 = 56Ω. VG adjustments are best performed using R3, R13 and R23. When using R4, R14 and R24 for such purposes, R4, R14 and R24 should be set to equal R2, R12 and R22 in order to establish a stable V <sub>N</sub> balance.
R5, 15, 25	For oscillation prevention resistor.
R6, 16, 26	For oscillation prevention resistor. This resistor's electrical output resides in the signal frequency and is calculated according to the following formula. $P R6 (16, 26) = \left( \frac{V_{CC \max}/\sqrt{2}}{1/2\pi f C5 (15, 25) + R6 (16, 26)} \right)^2 \times R6 (16, 26)$ <p>f = output signal frequency upper limit</p>
R8, 9, 28, 29	For ripple filter applied resistor. PO max, ripple rejection and power-up shock noise are modified according to this value. Set the electrical output of these resistors while keeping in mind the flow of peak current during recharging to C8, C9, C28 and C29 which function as pre-drive TR control resistors during load shorts.
L1, 2, 3	For oscillation prevention coil. Compensates phase dislocation caused by load capacitors and ensures stable oscillation.

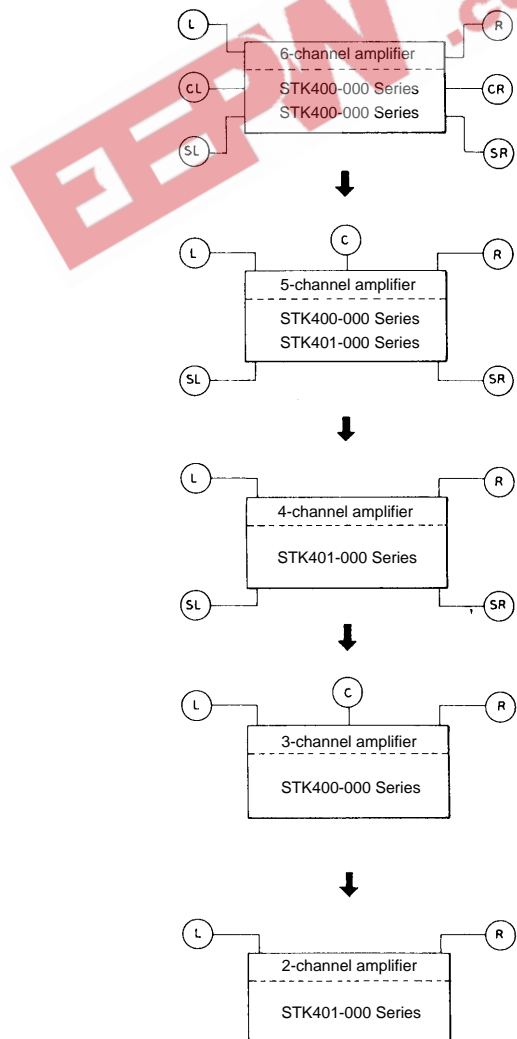
# STK400-040

## Series Configuration

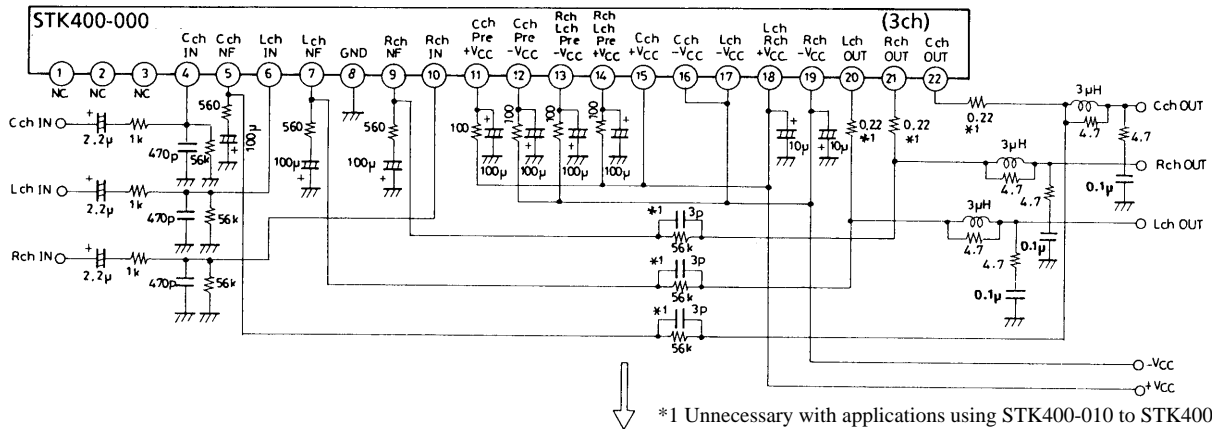
3ch Amp IC Name	Fixed Standard Output	2ch Amp IC Name	Fixed Standard Output	THD [%] f = 20 to 20kHz	Supply voltage				
					V <sub>CC</sub> max1	V <sub>CC</sub> max2	V <sub>CC</sub> 1	V <sub>CC</sub> 2	
STK400-010	10W X 3	STK401-010	10W X 2	0.4	—	±27	±18	±14	
STK400-020	15W X 3	STK401-020	15W X 2		—	±29	±20	±16	
STK400-030	20W X 3	STK401-030	20W X 2		—	±34	±23	±19	
STK400-040	25W X 3	STK401-040	25W X 2		—	±36	±25	±21	
STK400-050	30W X 3	STK401-050	30W X 2		—	±39	±26	±22	
STK400-060	35W X 3	STK401-060	35W X 2		—	±41	±28	±23	
STK400-070	40W X 3	STK401-070	40W X 2		—	±44	±30	±24	
STK400-080	45W X 3	STK401-080	45W X 2		—	±45	±31	±25	
STK400-090	50W X 3	STK401-090	50W X 2		—	±47	±32	±26	
STK400-100	60W X 3	STK401-100	60W X 2		—	±51	±35	±27	
STK400-110	70W X 3	STK401-110	70W X 2		—	±56.0	—	±38	—
—	—	STK401-120	80W X 2		—	±61.0	—	±42	—
—	—	STK401-130	100W X 2		—	±65.0	—	±45	—
—	—	STK401-140	120W X 2		—	±74.0	—	±51	—

V<sub>CC</sub> max1    R<sub>L</sub> = 6Ω operation  
 V<sub>CC</sub> max2    R<sub>L</sub> = 6Ω to 3Ω operation  
 V<sub>CC</sub>1        R<sub>L</sub> = 6Ω operation  
 V<sub>CC</sub>2        R<sub>L</sub> = 3Ω operation

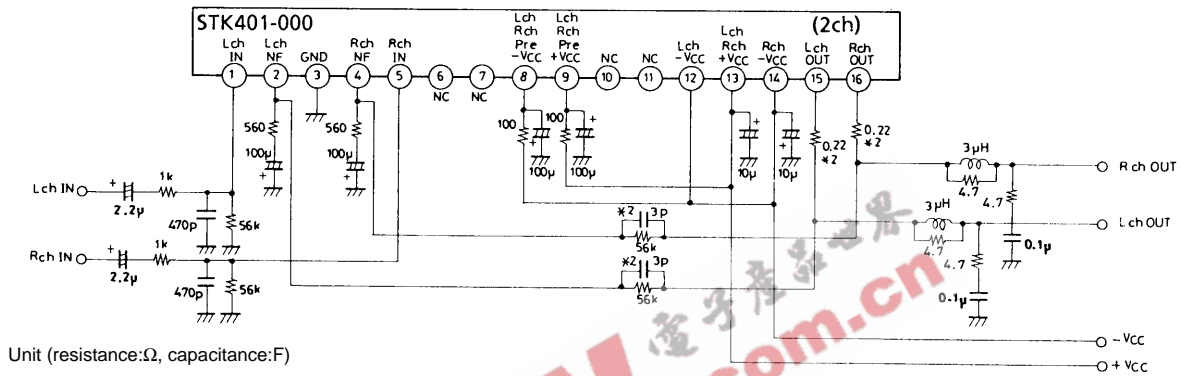
## Example of Set Design for Common PCB



External Circuit Diagram



\*1 Unnecessary with applications using STK400-010 to STK400-090.



Unit (resistance:Ω, capacitance:F)

\*2 Unnecessary with applications using STK401-010 to STK401-090.

Heat Radiation Design Considerations

The radiator thermal resistance  $\theta_{c-a}$  required for total substrate power dissipation  $P_d$  in the STK400-040 is determined as:

Condition 1: IC substrate temperature  $T_c$  not to exceed  $125^\circ\text{C}$ .

$$P_d \times \theta_{c-a} + T_a < 125^\circ\text{C} \dots\dots\dots (1)$$

where  $T_a$  is set assured ambient temperature.

Condition 2: Power transistor junction temperature  $T_j$  not to exceed  $150^\circ\text{C}$ .

$$P_d \times \theta_{c-a} + P_d/N \times \theta_{j-c} + T_a < 150^\circ\text{C} \dots\dots\dots (2)$$

where  $N$  is the number of power transistors and  $\theta_{j-c}$  the thermal resistance per power transistor chip. However, power transistor power consumption is  $P_d$  equally divided by  $N$  units.

Expressions (1) and (2) can be rewritten based on  $\theta_{c-a}$  to yield:

$$\theta_{c-a} < (125 - T_a) / P_d \dots\dots\dots (1)'$$

$$\theta_{c-a} < (150 - T_a) / P_d - \theta_{j-c} / N \dots\dots\dots (2)'$$

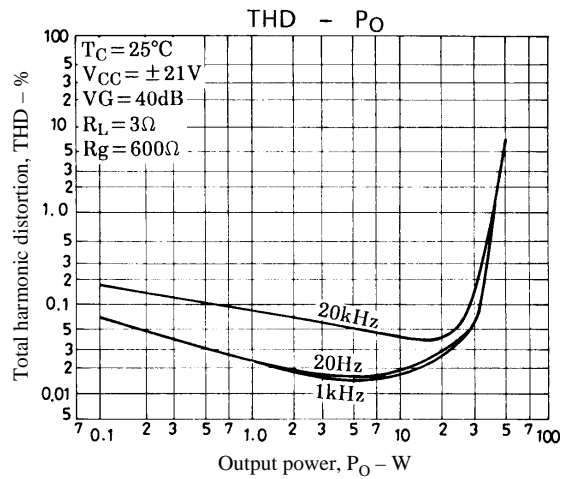
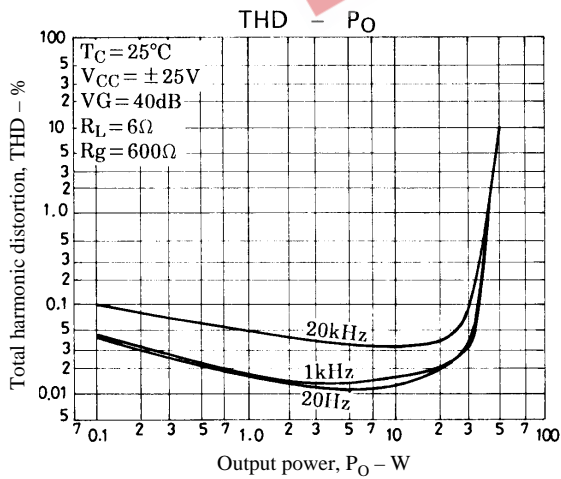
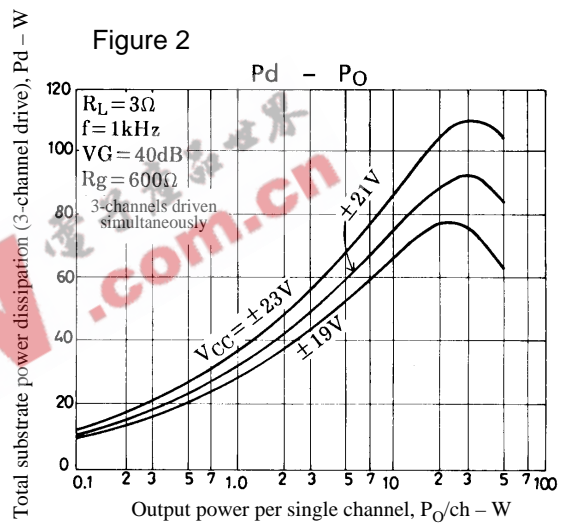
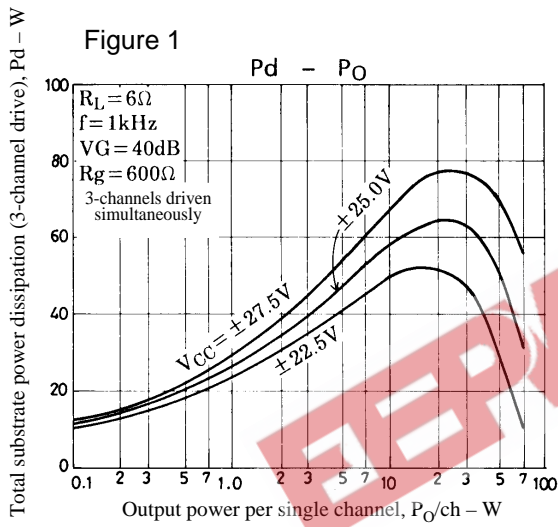
The required radiator thermal resistance will satisfy both of these expressions.

From expressions (1)' and (2)', the required radiator thermal resistance can be determined once the following specifications are known:

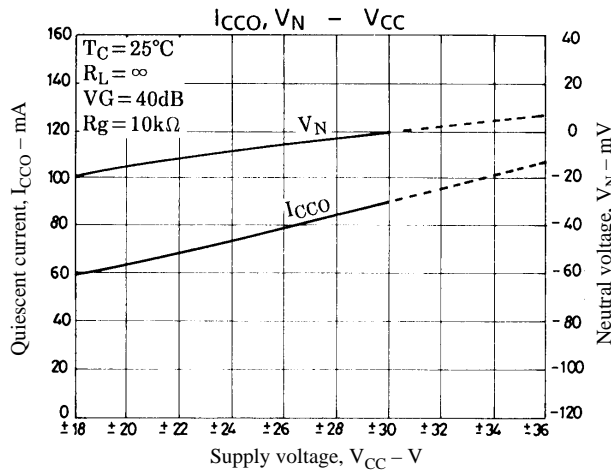
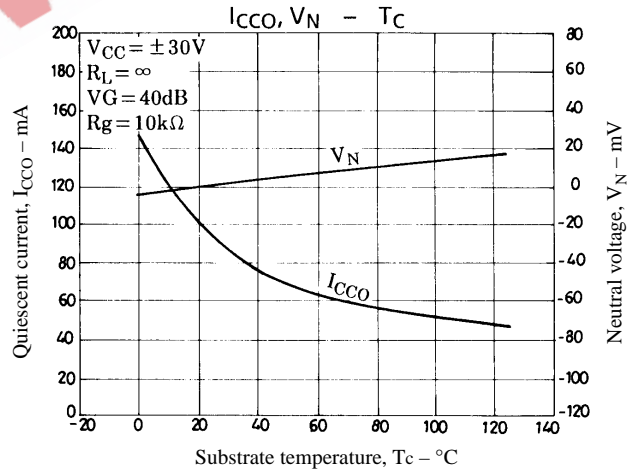
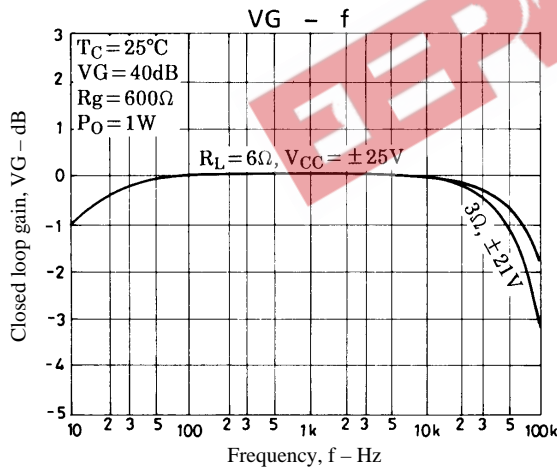
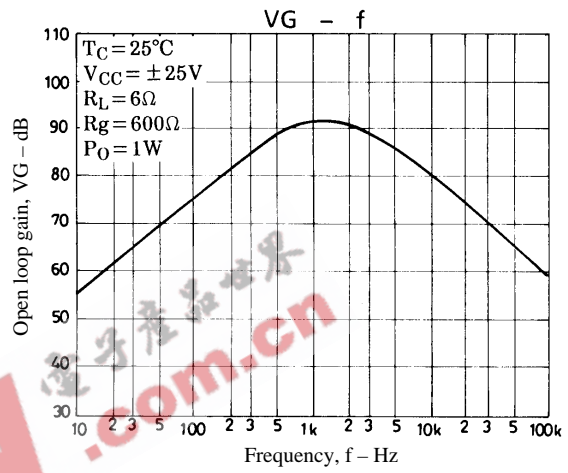
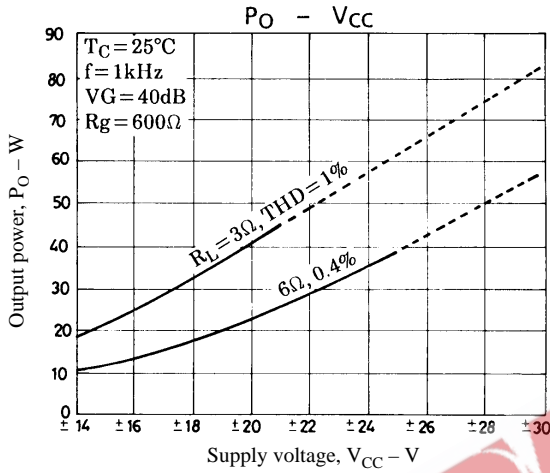
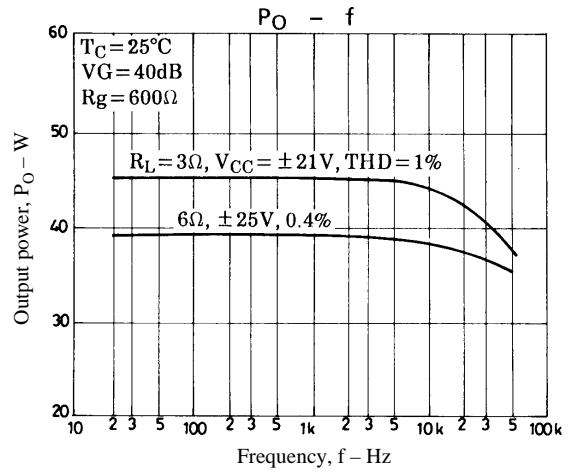
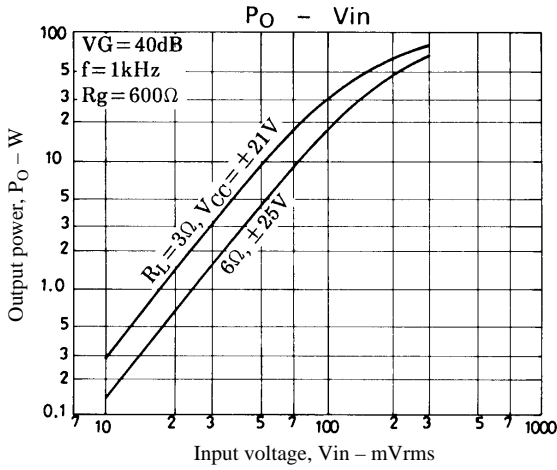
- Supply voltage  $V_{CC}$
- Load resistance  $R_L$
- Assured ambient temperature  $T_a$

The total substrate power consumption when STK400-040  $V_{CC}$  is  $\pm 25\text{ V}$  and  $R_L$  is  $6\ \Omega$ , for a continuous sine wave signal, is a maximum of  $63\text{ W}$  (Fig. 1). In general, when this sort of continuous signal is used for estimation of power consumption, the  $P_d$  used is 1/10th of  $P_{O\text{ max}}$  (slight variation depending on safety standard).

$P_d = 38W$  ( $1/10 P_O$  max = during 2.5W)











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